

QUADRUPLE 3-STATE BUFFERS OE HIGH

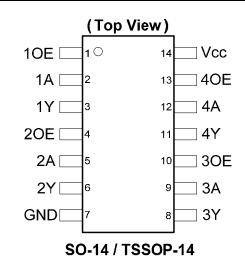
Description

The 74HC126 provides provides four independent buffer gates with 3-state outputs. Each buffer has a separate enable pin that if driven with a low logic level places the corresponding output in the high impedance state. The device is designed for operation with a power supply range of 2.0V to 6.0V.

Features

- Wide Supply Voltage Range from 2.0V to 6.0V
- Sinks or sources 4mA at V_{CC} = 4.5V
- CMOS low power consumption
- Schmitt Trigger Action at All Inputs
 - ESD Protection Exceeds JESD 22
 - 200-V Machine Model (A115-A)
 - 2000-V Human Body Model (A114-A)
 - Exceeds 1000-V Charged Device Model (C101C)
- Range of Package Options SO-14 and TSSOP-14
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Pin Assignments



Applications

- General Purpose Logic
- Wide array of products such as:
 - PCs, Networking, Notebooks, Netbooks
 - Computer Peripherals, Hard Drives, CD/DVD ROM
 - TV, DVD, DVR, Set Top Box

Notes:

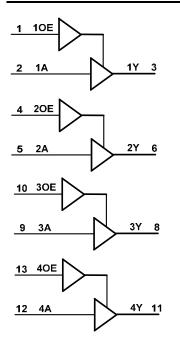
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 - See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Pin Descriptions

Pin Number	Pin Name	Function
1	10E	Data Enable Input (active low)
2	1A	Data Input
3	1Y	Data Output
4	20E	Data Enable Input (active low)
5	2A	Data Input
6	2Y	Data Output
7	GND	Ground
8	3Y	Data Output
9	3A	Data Input
10	30E	Data Enable Input (active low)
11	4Y	Data Outp
12	4A	Data Input
13	40E	Data Enable Input (active low)
14	Vcc	Supply Voltage

Logic Diagram



Function Table

Inp	Output	
OE	Α	Y
Н	Н	Н
Н	L	L
L	Х	Z



Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
Vcc	Supply Voltage Range	-0.5 to +7.0	V
VI	Input Voltage Range (Note 5)	-0.5 to +7.0	V
I_{IK} Input Clamp Current $V_I < -0.5V$ or $V_i > V_{CC} + 0.5V$		±20	mA
loк	Output Clamp Current $V_0 < -0.5V$ or $V_0 > V_{CC} + 0.5V$	±20	mA
lo	Continuous Output Current -0.5V < V _O V _{CC} +0.5V	+/- 25	mA
Icc	Continuous Current Through V _{CC}	50	mA
I _{GND}	Continuous Current Through GND	-50	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C
Ρτοτ	Total Power Dissipation	500	mW

Notes: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

5. Input Voltage cannot exceed V_{CC} to the extent the Maximum clamp current is exceeded.

Recommended Operating Conditions (Note 6) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	Supply Voltage		2.0	6.0	V
VI	Input Voltage		0	Vcc	V
Vo	Output Voltage		0	Vcc	V
		V _{CC} = 2.0V		625	
Δt/ΔV	Input Transition Rise or Fall Rate	V _{CC} = 4.5V		140	ns/V
		V _{CC} = 6.0V		85	
T _A	Operating Free-Air Temperature		-40	+125	°C

Note: 6. Unused inputs should be held at V_{CC} or ground.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Test Conditions	N.	T _A = -40°0	C to +85°C	T _A = -40°C	to +125°C	Unit
Symbol	Parameter	Test Conditions	Vcc	Min	Мах	Min	Мах	Uni
			2.0V	1.5		1.5		
VIH	High-level Input Voltage		4.5V	3.15		3.15		V
		6.0V	4.2		4.2			
			2.0V		0.5		0.5	
VIL	Low-level input voltage		4.5V		1.35		1.35	V
			6.0V		1.8		1.8	
		I _{OH} = -20μA	2.0V	1.9		1.9		
V _{OH} High-level Output Voltage	I _{OH} = -20μA	4.5V	4.4		4.4			
	High-level Output Voltage	I _{OH} = -20µА	6.0V	5.9		5.9		V
	I _{OH} = -4.0mA	4.5V	3.84		3.7			
		I _{OH} = -5.2mA	6.0V	5.34		5.2		
		I _{OL} = 20μA	2.0V		0.1		0.1	
		I _{OL} = 20μΑ	4.5V		0.1		0.1	
V _{OL}	Low-level Output Voltage	I _{OL} = 20μΑ	6.0V		0.1		0.1	V
		I _{OL} = 4mA	4.5V		0.33		0.44	
		I _{OL} = 5.2mA	6.0V		0.33		0.44	
I _{OZ}	Z State Leakage Current	V _O = 0 to 6.0V V _I = GND or 6.0V	6.0V		± 5.0		± 10	μA
I _I	Input Current	V _I = GND to 5.5V	6.0V		± 1		± 1	μA
Icc	Supply Current	$V_{I} = GND \text{ or } V_{CC}, I_{O} = 0$	6.0V		20		40	μA

Switching Characteristics

Symbol Parameter		Test	Test .		T _A = +25°C	;	-40°C to +85°C	-40°C to +125°C	Unit
Symbol	Farameter	Conditions	Vcc	Min	Тур	Max	Max	Max	Unit
	Dreneration		2.0V		30	100	125	150	
t _{PD}	Propagation Delay A _N to Y _N	Figure 1 C _L = 50pF	4.5V		11	20	25	30	ns
	Delay AN IO IN	CL - SOPF	6.0V	_	9	17	21	26	
		Figure 4	2.0V	_	41	125	155	190	
t _{EN} E <u>nab</u> le Time	Figure 1 C _L = 50pF	4.5V		15	25	31	38	ns	
	OE_N to Y_N	OE_N to Y_N $C_L = SOPF$	6.0V	_	12	21	26	32	
		Liguro 1	2.0V	_	41	125	155	190	
t _{DIS}	Disable Time	Figure 1	4.5V	_	15	25	31	38	ns
	OE_N to Y_N	C _L = 50pF	6.0V	_	12	21	26	32	
		Figure 1	2.0V		14	60	75	90	
tt Transition Time	Figure 1 C _L = 50pF	4.5V		5	12	15	18	ns	
		CL - SOPF	6.0V	_	4	10	13	15	

Operating Characteristics (@T_A = +25°C, unless otherwise specified.)

	Parameter	Test Conditions	V _{CC} = 6V Typ	Unit
C _{pd}	Power Dissipation Capacitance per Gate	f = 1 MHz	22	pF
CI	Input Capacitance	$V_1 = V_{CC} - or GND$	4	pF



Parameter Measurement Information

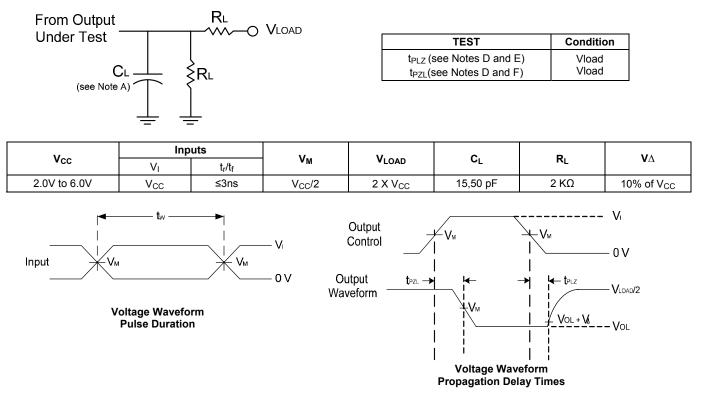


Figure 1 Load Circuit and Voltage Waveforms

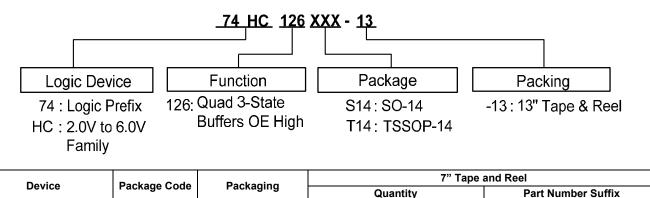
Notes: A. Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate \leq 1 MHz
- C. The inputs are measured one at a time with one transition per measurement.
- D. For the 3 state device t_{PLZ} and t_{PZL} are the same as $t_{\text{PD.}}$
- E. t_{PZL} is measured at V_M.
- D. t_{PLZ} is measured at V_OL +V_ Δ



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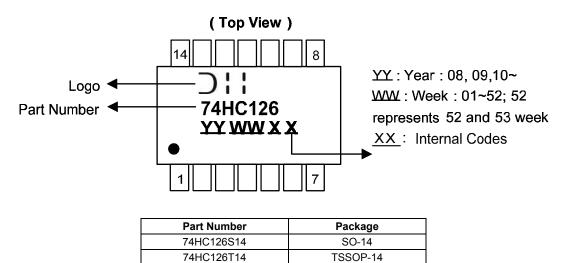
Ordering Information



	Device	Package Code	Packaging	7 1000	
	Device	Fackage Coue	Fackaying	Quantity	Part Number Suffix
Pb,	74HC126S14-13	S14	SO-14	2500/Tape & Reel	-13
Pb,	74HC126T14-13	T14	TSSOP-14	2500/Tape & Reel	-13

Marking Information

(1) SO-14, TSSOP-14

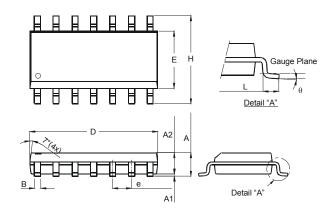




Package Outline Dimensions (All dimensions in mm.)

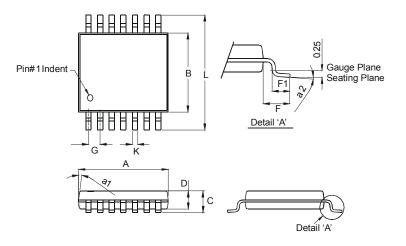
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

Package Type: SO-14



	SO-14			
Dim	Min	Max		
Α	1.47	1.73		
A1	0.10	0.25		
A2	1.45 Typ			
В	0.33	0.51		
D	8.53	8.74		
Е	3.80	3.99		
е	1.27	Тур		
н	5.80	6.20		
L	0.38	1.27		
θ	0°	8°		
All Di	mensions	s in mm		

Package Type: TSSOP-14



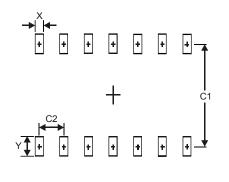
	TSSOP-14				
Dim	Min	Max			
a1	7° (4X)			
a2	0°	8°			
Α	4.9	5.10			
в	4.30	4.50			
С	_	1.2			
D	0.8	1.05			
F	1.00	Тур			
F1	0.45	0.75			
G	0.65	Тур			
κ	0.19	0.30			
L 6.40 Typ					
All Dir	nension	s in mm			



Suggested Pad Layout

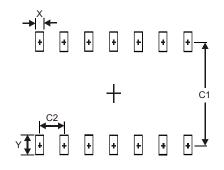
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.

Package Type: SO-14



Dimensions	Value (in mm)
Х	0.60
Y	1.50
C1	5.4
C2	1.27

Package Type: TSSOP-14



Dimensions	Value (in mm)
Х	0.45
Y	1.45
C1	5.9
C2	0.65



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